



NPN Triple Diffused Planar Silicon Transistor

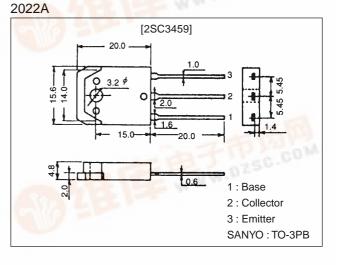


Features

- · High breakdown voltage and high reliability.
- · Fast switching speed ($t_f : 0.1 \mu s$ typ).
- \cdot Wide ASO.
- · Adoption of MBIT process.

Package Dimensions

unit:mm



Specifications

Absolute Maximum Ratings at Ta = 25°C

Parameter	Symbol	Conditions	Ratings	Unit
Collector-to-Base Voltage	VCBO		1100	V
Collector-to-Emitter Voltage	VCEO		800	V
Emitter-to-Base Voltage	VEBO	14	7	V
Collector Current	IC		4.5	А
Collector Current (Pulse)	ICP	PW≤300µs, Duty Cycle≤10%	15	A
Base Current	Ι _Β		2	A
Collector Dissipation	PC	Tc=25°C	90	W
Junction Temperature	Tj		150	°C
Storage Temperature	Tstg		-55 to +150	°C

Electrical Characteristics at Ta = 25°C

Symbol	Conditions	Ratings			Unit
		min	typ	max	
I _{CBO}	V _{CB} =800V, I _E =0			10	μA
IEBO	V _{EB} =5V, I _C =0			10	μA
h _{FE} 1	V _{CE} =5V, I _C =0.3A	10*	-51	40*	NO.
h _{FE} 2	V _{CE} =5V, I _C =1.5A	8		SV	
fT	V _{CE} =10V, I _C =0.3A	W W	15		MHz
Cob	V _{CB} =10V, f=1MHz		90		pF
	ICBO IEBO hFE1 hFE2 fT	ICBO VCB=800V, IE=0 IEBO VEB=5V, IC=0 hFE1 VCE=5V, IC=0.3A hFE2 VCE=5V, IC=1.5A fT VCE=10V, IC=0.3A	Immin Immin ICBO VCB=800V, IE=0 IEBO VEB=5V, IC=0 hFE1 VCE=5V, IC=0.3A hFE2 VCE=5V, IC=1.5A fT VCE=10V, IC=0.3A	Symbol Conditions min typ ICBO VCB=800V, IE=0 </td <td>Symbol Conditions min typ max ICBO VCB=800V, IE=0 10 10 IEBO VEB=5V, IC=0 10 10 hFE1 VCE=5V, IC=0.3A 10* 40* hFE2 VCE=5V, IC=1.5A 8 15 fT VCE=10V, IC=0.3A 15 15</td>	Symbol Conditions min typ max ICBO VCB=800V, IE=0 10 10 IEBO VEB=5V, IC=0 10 10 hFE1 VCE=5V, IC=0.3A 10* 40* hFE2 VCE=5V, IC=1.5A 8 15 fT VCE=10V, IC=0.3A 15 15

*: The h_{FE}l of the 2SC3459 is classified as follows. When specifying the h_{FE}l rank, specify two ranks or more in principle.

10 K 20 15 L 30 20 M 40

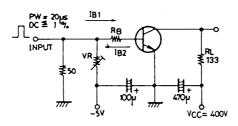
Any and all SANYO products described or contained herein do not have specifications that can handle applications that require extremely high levels of reliability, such as life-support systems, aircraft's control systems, or other applications whose failure can be reasonably expected to result in serious physical and/or material damage. Consult with your SANYO representative nearest you before using any SANYO products described or contained herein in such applications.

SANYO assumes no responsibility for equipment failures that result from using products at values that exceed, even momentarily, rated values (such as maximum ratings, operating condition ranges,or other parameters) listed in products specifications of any and all SANYO products described or contained
F herein.

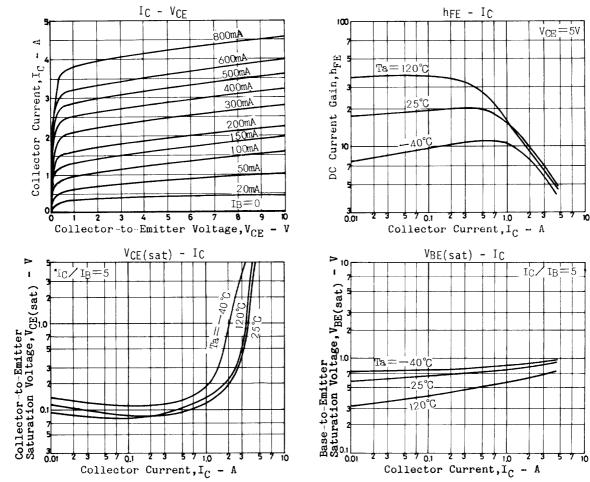
2SC3459

Parameter	Symbol	Conditions		Ratings		
	Symbol		min	typ	max	Unit
Collector-to-Emitter Saturation Voltage	V _{CE(sat)}	I _C =2A, I _B =0.4A			2.0	V
Base-to-Emitter Saturation Voltage	V _{BE(sat)}	I _C =2A, I _B =0.4A			1.5	V
Collector-to-Base Breakdown Voltage	V(BR)CBO	I _C =1mA, I _E =0	1100			V
Collector-to-Emitter Breakdown Voltage	V(BR)CEO	I _C =5mA, R _{BE} =∞	800			V
Emitter-to-Base Breakdown Voltage	V(BR)EBO	I _E =1mA, I _C =0	7			V
Collector-to-Emitter Sustain Voltage	V _{CEX(sus)}	I _C =2A, I _{B1} =-I _{B2} =0.4A, L=2mH, clamped	800			V
Turn-ON Time	ton	V_{CC} =400V, 5I _{B1} =-2.5I _{B2} =I _C =3A, R _L =133 Ω			0.5	μs
Storage Time	tstg	V_{CC} =400V, 5I _{B1} =-2.5I _{B2} =I _C =3A, R _L =133 Ω			3.0	μs
Fall Time	t _f	V_{CC} =400V, 5I _{B1} =-2.5I _{B2} =I _C =3A, R _L =133Ω			0.3	μs

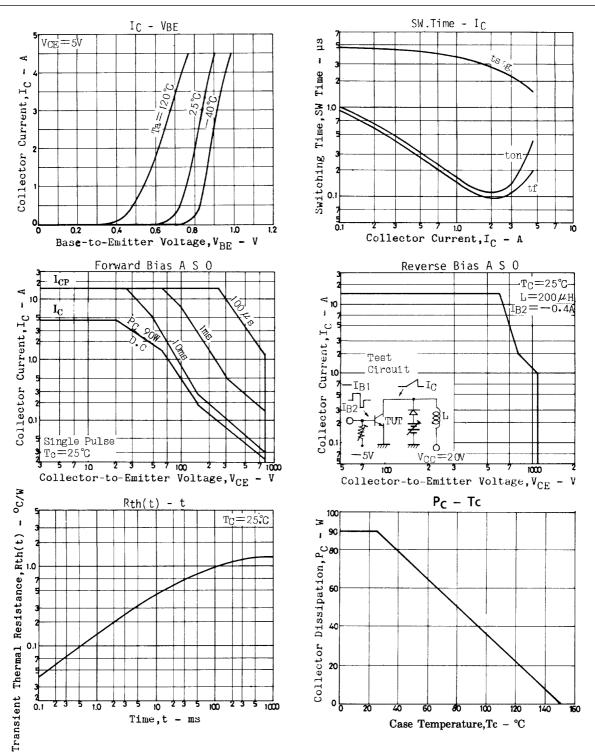
Switching Time Test Circuit



Unit (resistance : Ω , capacitance : F)



2SC3459



- Specifications of any and all SANYO products described or contained herein stipulate the performance, characteristics, and functions of the described products in the independent state, and are not guarantees of the performance, characteristics, and functions of the described products as mounted in the customer's products or equipment. To verify symptoms and states that cannot be evaluated in an independent device, the customer should always evaluate and test devices mounted in the customer's products or equipment.
- SANYO Electric Co., Ltd. strives to supply high-quality high-reliability products. However, any and all semiconductor products fail with some probability. It is possible that these probabilistic failures could give rise to accidents or events that could endanger human lives, that could give rise to smoke or fire, or that could cause damage to other property. When designing equipment, adopt safety measures so that these kinds of accidents or events cannot occur. Such measures include but are not limited to protective circuits and error prevention circuits for safe design, redundant design, and structural design.
- In the event that any or all SANYO products(including technical data,services) described or contained herein are controlled under any of applicable local export control laws and regulations, such products must not be exported without obtaining the export license from the authorities concerned in accordance with the above law.
- No part of this publication may be reproduced or transmitted in any form or by any means, electronic or mechanical, including photocopying and recording, or any information storage or retrieval system, or otherwise, without the prior written permission of SANYO Electric Co., Ltd.
- Any and all information described or contained herein are subject to change without notice due to product/technology improvement, etc. When designing equipment, refer to the "Delivery Specification" for the SANYO product that you intend to use.
- Information (including circuit diagrams and circuit parameters) herein is for example only ; it is not guaranteed for volume production. SANYO believes information herein is accurate and reliable, but no guarantees are made or implied regarding its use or any infringements of intellectual property rights or other rights of third parties.

This catalog provides information as of November, 1998. Specifications and information herein are subject to change without notice.